

# **Maximum Ratings** (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Drain-Source Voltage		V <sub>DSS</sub>	100	V
Gate-Source Voltage		Vgss	±20	V
Continuous Drain Comment (Nata C) 1/2 - 401/	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	I <sub>D</sub>	13 10	А
Continuous Drain Current (Note 6) Vgs = 10V	T <sub>C</sub> = +25°C T <sub>C</sub> = +70°C	ΙD	48 38	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		I <sub>DM</sub>	110	Α
Maximum Continuous Body Diode Forward Current (Note 6)		ls	2.5	Α
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)		Іѕм	110	А
Avalanche Current, L = 0.3mH		las	21	Α
Avalanche Energy, L = 0.3mH		Eas	66	mJ

## Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5)	PD	1.8	W
Thermal Resistance, Junction to Ambient (Note 5)	Reja	68	°C/W
Total Power Dissipation (Note 6)	PD	2.5	W
Thermal Resistance, Junction to Ambient (Note 6)	Reja	50	°C/W
Thermal Resistance, Junction to Case (Note 6)	Rejc	4	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

# **Electrical Characteristics** (T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BVDSS	100	_	_	V	$V_{GS} = 0V$ , $I_D = 1mA$	
Zero Gate Voltage Drain Current	IDSS	_	_	1	μΑ	V <sub>DS</sub> = 80V, V <sub>GS</sub> = 0V	
Gate-Source Leakage	IGSS	_	-	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	Vgs(TH)	1.3	_	2.5	V	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$	
Static Drain-Source On-Resistance	-	_	7.1	9	mΩ	$V_{GS} = 10V, I_D = 10A$	
Static Dialif-Source Off-Resistance	R <sub>DS(ON)</sub>	_	9.7	13.8		$V_{GS} = 4.5V, I_D = 6A$	
Diode Forward Voltage	$V_{SD}$	_	8.0	1.2	V	$V_{GS} = 0V, I_{S} = 20A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	_	2309	_	pF	V <sub>DS</sub> = 50V, V <sub>GS</sub> = 0V, f = 1MHz	
Output Capacitance	Coss		536				
Reverse Transfer Capacitance	Crss		13.7				
Gate Resistance	Rg		1.9		Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Total Gate Charge (VGS = 10V)	Qg		40.2			V <sub>DD</sub> = 50V, I <sub>D</sub> = 20A	
Total Gate Charge (V <sub>GS</sub> = 4.5V)	$Q_g$		20.2		nC		
Gate-Source Charge	Qgs		7.0		IIC		
Gate-Drain Charge	$Q_{gd}$	_	8.5	_			
Turn-On Delay Time	td(ON)	_	5.4	_		$V_{DD} = 50 \text{V}, \text{ V}_{GS} = 10 \text{V},$ $I_{D} = 20 \text{A}, \text{ R}_{g} = 3 \Omega$	
Turn-On Rise Time	t <sub>R</sub>	_	10.6	_	ns		
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	28.3	_	115		
Turn-Off Fall Time	tF	_	14.9	_			
Body Diode Reverse Recovery Time	t <sub>RR</sub>	_	44.3	_	ns	004 4744 40047	
Body Diode Reverse Recovery Charge	Q <sub>RR</sub>	_	65.5	_	nC	${\text{nC}}$ IF = 20A, di/dt = 100A/µs	

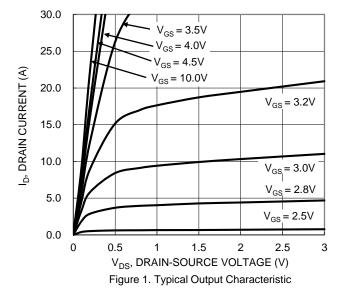
Notes: 5. Device mounted on FR-4 substrate PCB, 2oz copper, with minimum recommended pad layout.

<sup>6.</sup> Device mounted on FR-4 substrate PCB, 2oz copper, with 1inch square copper plate.

<sup>7.</sup> Short duration pulse test used to minimize self-heating effect.

<sup>8.</sup> Guaranteed by design. Not subject to product testing.





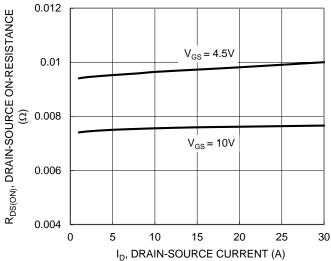


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

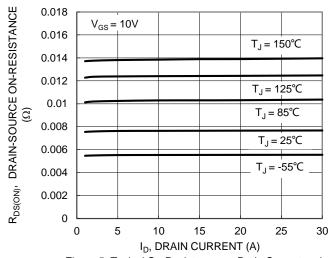


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature

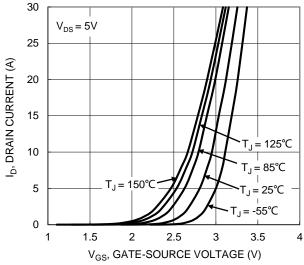
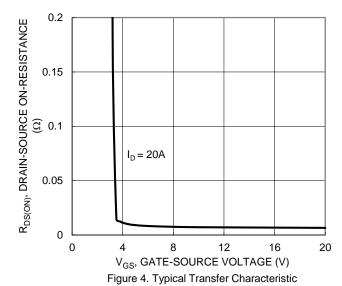


Figure 2. Typical Transfer Characteristic



2 R<sub>DS(ON)</sub>, DRAIN-SOURCE ON-RESISTANCE (NORMALIZED) 1.8  $V_{GS} = 10V, I_{D} = 10A$ 1.6 1.4 1.2 1  $V_{GS} = 4.5V, I_{D} = 6A$ 0.8 0.6 25 50 75 100 125 -50 T<sub>.I</sub>, JUNCTION TEMPERATURE (°C)

Figure 6. On-Resistance Variation with Junction Temperature





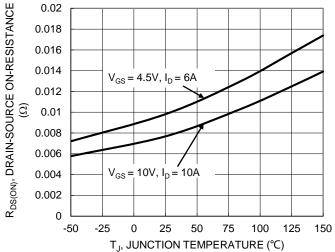


Figure 7. On-Resistance Variation with Junction Temperature

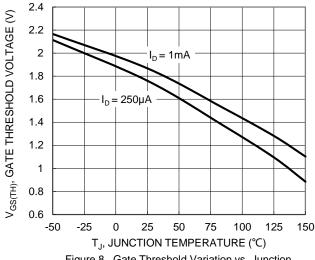


Figure 8. Gate Threshold Variation vs. Junction Temperature

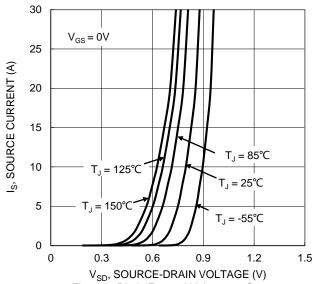
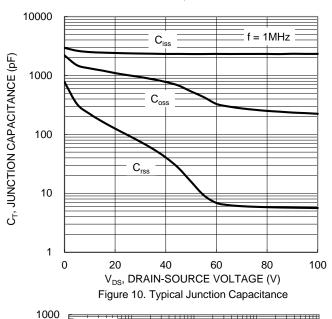
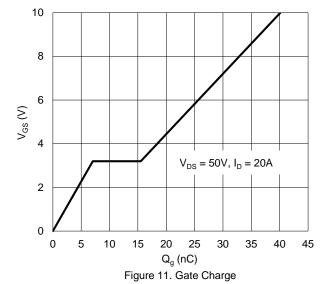


Figure 9. Diode Forward Voltage vs. Current





100 -----ID, DRAIN CURRENT (A) 10  $T_{J(Max)} = 150$ °C  $T_C = 25^{\circ}C$ Single Pulse DUT on 1\*MRP Board  $P_W = 10s$  $V_{GS} = 10V$ DC 0.01 0.1 10 1000 V<sub>DS</sub>, DRAIN-SOURCE VOLTAGE (V)

R<sub>DS(ON)</sub> Limited

Figure 12. SOA, Safe Operation Area

 $_{v} = 10 ms$ 



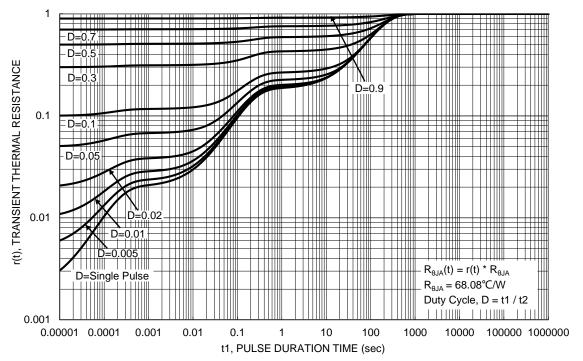
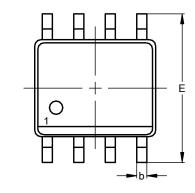


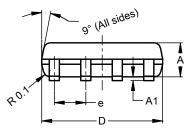
Figure 13. Transient Thermal Resistance

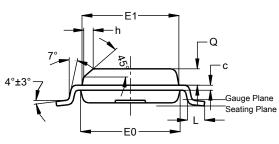


### **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.





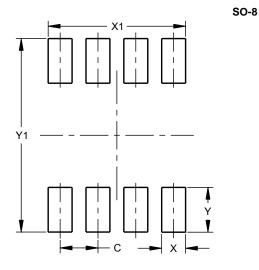


SO-8

SO-8					
Dim	Min	Max	Тур		
Α	1.40	1.50	1.45		
A1	0.10	0.20	0.15		
b	0.30	0.50	0.40		
С	0.15	0.25	0.20		
D	4.85	4.95	4.90		
Е	5.90	6.10	6.00		
E1	3.80	3.90	3.85		
E0	3.85	3.95	3.90		
е			1.27		
h		1	0.35		
L	0.62	0.82	0.72		
Q	0.60	0.70	0.65		
All Dimensions in mm					

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.



<b>Dimensions</b>	Value (in mm)
С	1.27
Х	0.802
X1	4.612
Y	1.505
Y1	6.50



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